



#### 60V LOW V<sub>CE(sat)</sub> NPN SURFACE MOUNT TRANSISTOR

#### Features

- Epitaxial Planar Die Construction
- Ideal for Medium Power Amplification and Switching
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

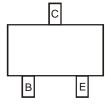
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.008 grams (approximate)



Top View



Device Symbol



Pin-Out Top

# Ordering Information (Note 3)

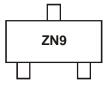
Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DSS4160T-7	ZN9	7	8	3,000

Notes: 1. No purposefully added lead.

2. Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com

3. For packaging details, go to our website at http://www.diodes.com

## **Marking Information**



ZN9 = Product Type Marking Code



#### **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	80	V
Collector-Emitter Voltage	V <sub>CEO</sub>	60	V
Emitter-Base Voltage	V <sub>EBO</sub>	5	V
Continuous Collector Current	Ic	1	A
Peak Pulse Collector Current	I <sub>CM</sub>	2	A
Base Current (DC)	IB	300	mA
Peak Base Current	I <sub>BM</sub>	1	A

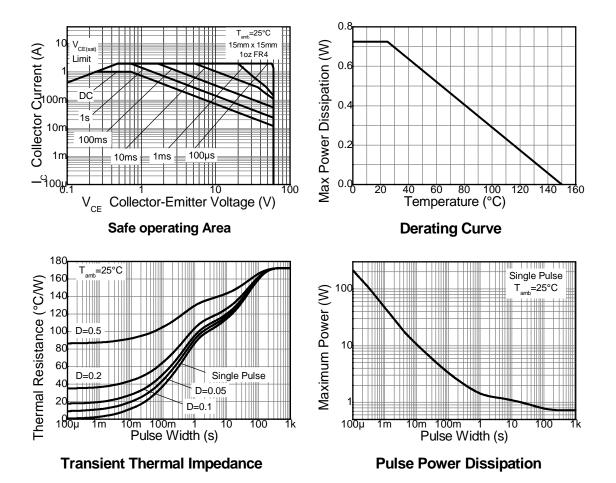
### Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	725	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ ext{ heta}JA}$	172	°C/W
Thermal Resistance, Junction to Ambient Air (Note 4)	R <sub>0JA</sub>	79	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes: 4. Operated under pulsed conditions: pulse width  $\leq 100$  ms, duty cycle  $\leq 0.25$ .

5. Device mounted on 15mm x 15mm x1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

### **Thermal Characteristics**



DSS4160T Document number: DS35531 Rev. 1 - 2 Downloaded from <u>Elcodis.com</u> electronic components distributor



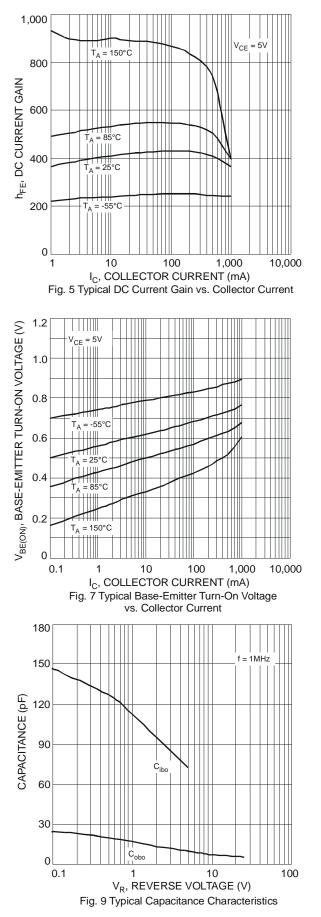
# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

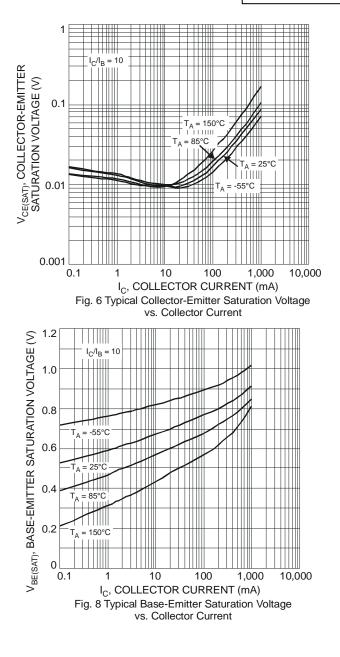
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	80	—		V	$I_C = 100 \mu A$
Collector-Emitter Breakdown Voltage (Note 6)	BV <sub>CEO</sub>	60	_	_	V	$I_{\rm C} = 10 {\rm mA}$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	5	_	—	V	$I_E = 100 \mu A$
Collector-Base Cutoff Current	1	_	_	100	nA	$V_{CB} = 60V, I_E = 0$
	I <sub>CBO</sub>	_	_	50	μΑ	$V_{CB} = 60V, I_E = 0, T_A = 150^{\circ}C$
Collector Cutoff Current	I <sub>CES</sub>	_	—	100	nA	$V_{EB} = 60V, I_{BE} = 0$
Emitter-Base Cutoff Current	I <sub>EBO</sub>	_	_	100	nA	$V_{EB} = 5V, I_{C} = 0$
		250	_	_		$V_{CE} = 5V, I_C = 1mA$
DC Current Gain (Note 6)	h <sub>FE</sub>	200	_	_		$V_{CE} = 5V, I_{C} = 500mA$
		100	_	_	1	$V_{CE} = 5V, I_C = 1A$
			_	115		$I_{\rm C} = 100 {\rm mA}, I_{\rm B} = 1 {\rm mA}$
Collector-Emitter Saturation Voltage (Note 6)	V <sub>CE(sat)</sub>		_	150	mV	$I_{\rm C} = 500$ mA, $I_{\rm B} = 50$ mA
	. ,	_	_	280		$I_{C} = 1A, I_{B} = 100 \text{mA}$
Equivalent On-Resistance	R <sub>CE(sat)</sub>		_	280	mΩ	I <sub>E</sub> = 1A, I <sub>B</sub> = 100mA
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>		_	1.1	V	$I_{C} = 1A, I_{B} = 50mA$
Base-Emitter Turn-on Voltage	V <sub>BE(on)</sub>	_	_	0.9	V	$V_{CE} = 5V, I_{C} = 1A$
Transition Frequency	f⊤	150	_	_	MHz	$V_{CE} = 10V$ , $I_C = 50mA$ , f = 100MHz
Output Capacitance	C <sub>obo</sub>	_	_	10	pF	$V_{CB} = 10V$ , f = 1MHz
Turn-On Time	t <sub>on</sub>	_	63	_	ns	
Delay Time	t <sub>d</sub>	_	33	_	ns	
Rise Time	tr		30	_	ns	$V_{\rm CC} = 10V, I_{\rm C} = 0.5A,$
Turn-Off Time	t <sub>off</sub>	_	420		ns	$I_{B1} = I_{B2} = 25 \text{mA}$
Storage Time	ts	_	380		ns	]
Fall Time	t <sub>f</sub>	_	40		ns	]

Notes: 6. Measured under pulsed conditions. Pulse width =  $300\mu$ s. Duty cycle  $\leq 2\%$ .





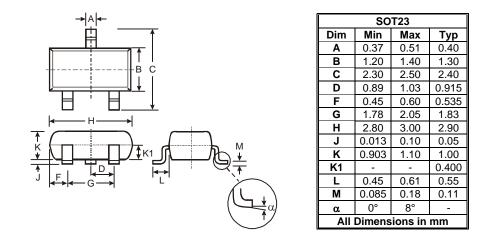




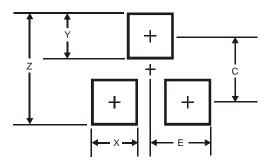


DSS4160T

# **Package Outline Dimensions**



# **Suggested Pad Layout**



Dimensions	Value (in mm)		
Z	2.9		
Х	0.8		
Y	0.9		
С	2.0		
E	1.35		



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